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1. Name of conveying party(ies):

Takehiro TAKAHASHI

Additional name(s) of conveying party(ies) attached? Yes [] No [X]

3. Nature of conveyance:

- Assignment [] Merger
- [] Security Agreement [] Change of Name
- [] Other

Execution Date: June 18, 2009

2. Name and address of receiving party(ies):

Name: **NIHON DEMPA KOGYO CO., LTD.**

Internal Address:

Street Address: **50-1, Sasazuka 1-chome,
Shibuya-ku, Tokyo, 151-8569, Japan**

Additional name(s) & address(es) attached? [] Yes [X] No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the filing date of the application is **August 12, 2009**

A. Patent Application No.(s)

12449533

B. Patent No.(s)

Additional numbers attached? [] Yes [X] No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Frank J. Jordan, Esq.

Internal Address: Jordan and Hamburg LLP
Chanin Building
Suite 4000

Street Address: 122 East 42nd Street

City: New York State: New York Zip: 10168

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41):.....\$40.00

[] Enclosed

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Frank J. Jordan, Esq.
Name of Person Signing

Frank J. Jordan
Signature

August 12, 2009
Date

Total number of pages including cover sheet, attachments, and documents: 2

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ASSIGNMENT

12/449533

For value received, I/we, Takehiro TAKAHASHI

residing respectively at c/o NIHON DEMPA KOGYO CO., LTD. / Sayama Plant

1275-2, Oaza, Kamihirose, Sayama-shi, Saitama, 350-1821, Japan

hereby sell, assign, and transfer to NIHON DEMPA KOGYO CO., LTD.,

a corporation existing under the laws of Japan, located at 50-1, Sasazuka 1-chome,

Shibuya-ku, Tokyo, 151-8569, Japan.

and its successors, assigns, and legal representatives, the entire right, title, and interest for all

countries including the United States of America, in and to certain inventions relating to

PACKAGE-TYPE PIEZOELECTRIC RESONATOR AND METHOD OF MANUFACTURING

PACKAGE-TYPE PIEZOELECTRIC RESONATOR which corresponds to Patent

Cooperation Treaty International Application No. PCT/JP2008/053126

filed February 19, 2008 of which this application is entry into

the U. S. A. National Stage, and which is

described in an application for Letters Patent of the United States, executed by me/us on this date, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I/we have full right so to do, and agree that I/we will communicate to said Company or its representatives any facts known to me/us respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature Takehiro Takahashi Date Jun. 18, 2009
Takehiro TAKAHASHI

Signature _____ Date _____

Signature _____ Date _____

Signature _____ Date _____